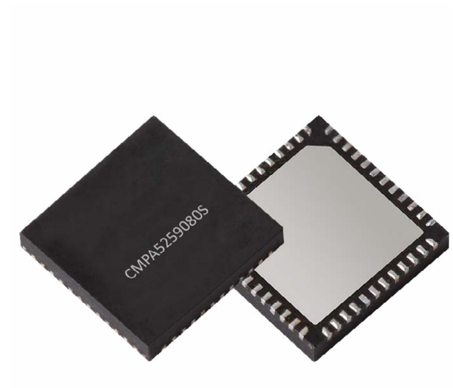
CMPA5259080S

80 W, 5.0 - 5.9 GHz, GaN MMIC, Power Amplifier

Description

The CMPA5259080S is a gallium nitride (GaN) high electron mobility transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity, and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier design approach enabling high power and power added efficiency to be achieved in a 7 mm x 7 mm surface mount (QFN package).



Package Types: 7 x 7 QFN
PN's: CMPA5259080S

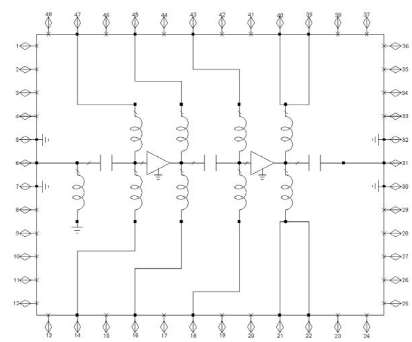
Features

- >48% typical power added efficiency
- 29 dB small signal gain
- 110 W typical P_{SAT}
- Operation up to 40 V
- High breakdown voltage
- High temperature operation

Applications

- Civil and military pulsed radar amplifiers

Note: Features are typical performance across frequency under 25 °C operation.
Please reference performance charts for additional details.



Typical Performance Over 5.2 - 5.9 GHz (T_C = 25 °C)

Parameter	5.2 GHz	5.5 GHz	5.9 GHz	Units
Small Signal Gain[1,2]	29.0	30.5	28.1	dB
Output Power[1,3]	112.9	112.5	99.9	W
Power Gain[1,3]	21.4	21.4	21.0	dB
Power Added Efficiency[1,3]	47	49	47	%

Notes:
[1] V_{DD} = 40 V, I_{DQ} = 350 mA.
[2] Measured at P_{IN} = -20 dBm.
[3] Measured at P_{IN} = 29 dBm and 500 µs, duty cycle = 20%.

RoHS compliant

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Rev. 0.2, SEPTEMBER 2023

Absolute Maximum Ratings (Not Simultaneous) at 25 °C

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	120	V_{DC}	25 °C
Gate-Source Voltage	V_{GS}	-10, +2	V_{DC}	25 °C
Storage Temperature	T_{STG}	-55, +150	°C	
Maximum Forward Gate Current	I_G	23.2	mA	25 °C
Maximum Drain Current	I_{DMAX}	4.8	A	
Soldering Temperature	T_S	260	°C	

Electrical Characteristics (Frequency = 5.2 GHz to 5.9 GHz Unless Otherwise Stated; T_C = 25 °C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.6	-3.1	-2.4	V	V_{DS} = 10 V, I_D = 23.2 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–	V_{DC}	V_{DD} = 40 V, I_{DQ} = 350 mA
Saturated Drain Current[1]	I_{DS}	16.7	23.2	–	A	V_{DS} = 6.0 V, V_{GS} = 2.0 V
Drain-Source Breakdown Voltage	V_{BD}	100	–	–	V	V_{GS} = -8 V, I_D = 23.2 mA
RF Characteristics[2,3]						
Small Signal Gain	$S21_1$	–	27	–	dB	P_{IN} = -20 dBm, Freq = 5.2 - 5.9 GHz
Output Power	P_{OUT1}	–	105	–	W	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.2 GHz
Output Power	P_{OUT2}	–	102	–	W	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29dBm, Freq = 5.5 GHz
Output Power	P_{OUT3}	–	112	–	W	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.9 GHz
Power Added Efficiency	PAE_1	–	50	–	%	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.2 GHz
Power Added Efficiency	PAE_2	–	48	–	%	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.5 GHz
Power Added Efficiency	PAE_3	–	48	–	%	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.9 GHz
Power Gain	G_P	–	21	–	dB	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.2 GHz
Power Gain	G_P	–	21	–	dB	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.5 GHz
Power Gain	G_P	–	22	–	dB	V_{DD} = 40 V, I_{DQ} = 350 mA, P_{IN} = 29 dBm, Freq = 5.9 GHz
Input Return Loss	S11	–	-10	–	dB	P_{IN} = -20 dBm, 5.2 - 5.9 GHz
Output Return Loss	S22	–	-4	–	dB	P_{IN} = -20 dBm, 5.2 - 5.9 GHz
Output Mismatch Stress	VSWR	–	–	3 : 1	Ψ	No Damage at All Phase Angles

Notes:
[1] Scaled from PCM data.
[2] Measured in CMPA5259080S high volume test fixture at 5.2, 5.5 and 5.9 GHz and may not show the full capability of the device due to source inductance and thermal performance.
[3] Unless otherwise noted: Pulse width = 25 µs, duty cycle = 1%.

Thermal Characteristics

Parameter	Symbol	Rating	Units	Conditions
Operating Junction Temperature	T_J	225	°C	
Thermal Resistance, Junction to Case (Packaged)[1]	$R_{\theta JC}$	0.95	°C/W	Pulse Width = 500 µs, Duty Cycle = 20%

Note:
[1] Simulated for the CMPA5259080S at P_{DISS} = 120 W.

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Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: V_D = 40 V, I_{DQ} = 350 mA, pulse width = 500 µs, duty cycle = 20%, P_{IN} = 29 dBm, T_{BASE} = +25 °C

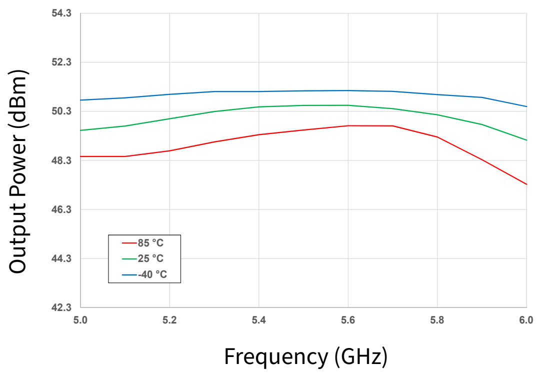

Figure 1. Output Power vs Frequency as a Function of Temperature

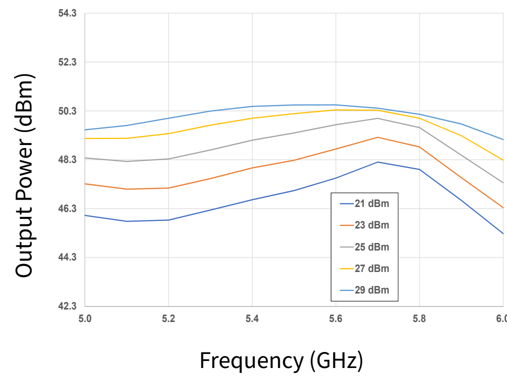

Figure 2. Output Power vs Frequency as a Function of Input Power

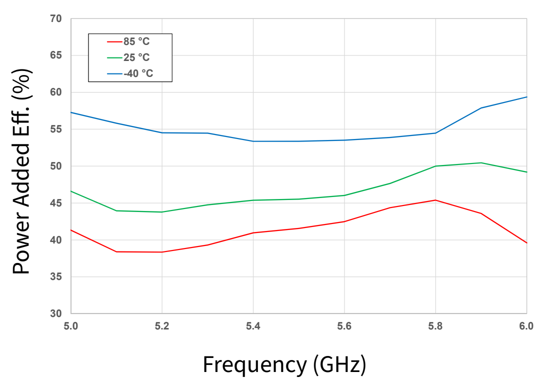

Figure 3. Power Added Eff. vs Frequency as a Function of Temperature

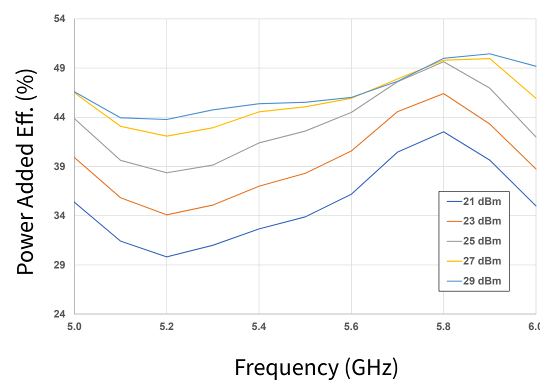

Figure 4. Power Added Eff. vs Frequency as a Function of Input Power

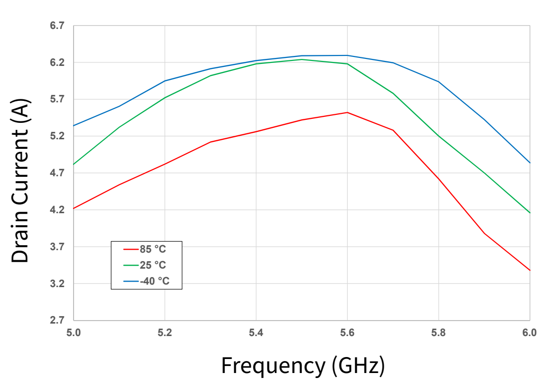

Figure 5. Drain Current vs Frequency as a Function of Temperature

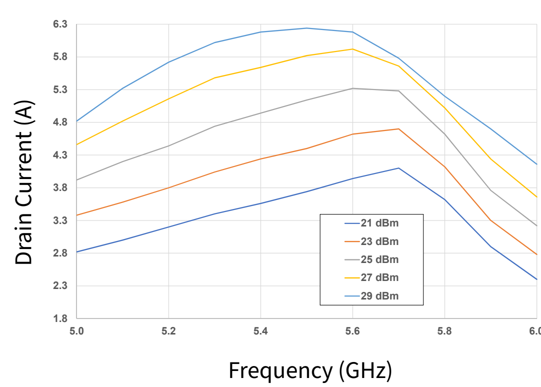

Figure 6. Drain Current vs Frequency as a Function of Input Power

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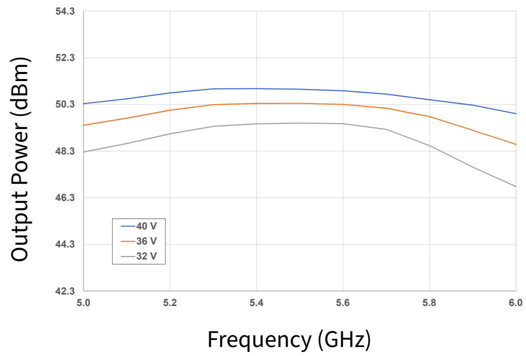

Figure 7. Output Power vs Frequency as a Function of V_D

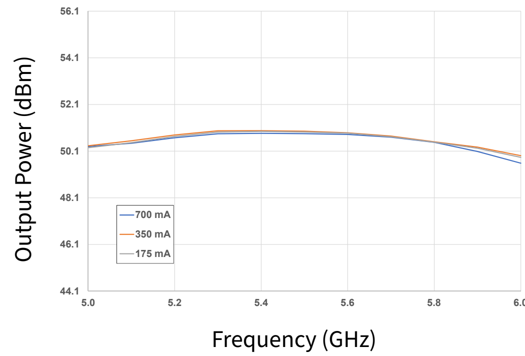

Figure 8. Output Power vs Frequency as a Function of I_{DQ}

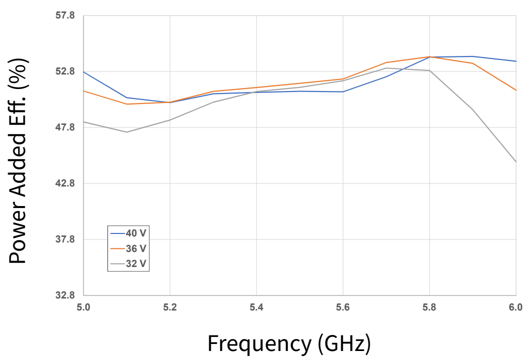

Figure 9. Power Added Eff. vs Frequency as a Function of V_D

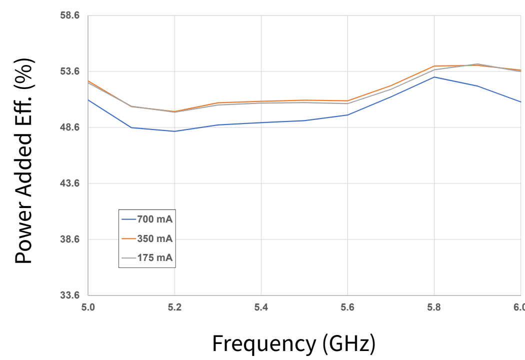

Figure 10. Power Added Eff. vs Frequency as a Function of I_{DQ}

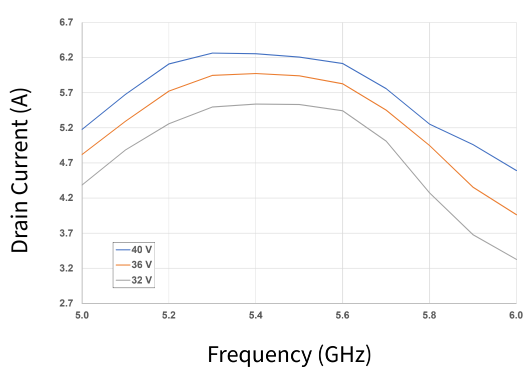

Figure 11. Drain Current vs Frequency as a Function of V_D

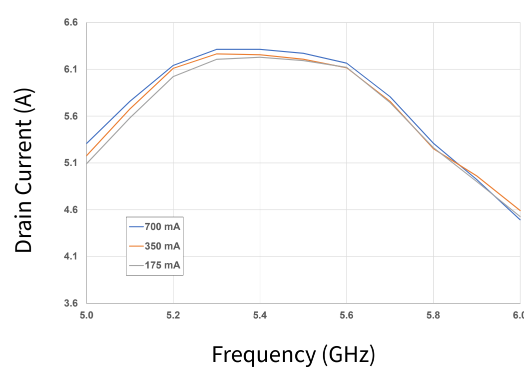

Figure 12. Drain Current vs Frequency as a Function of I_{DQ}

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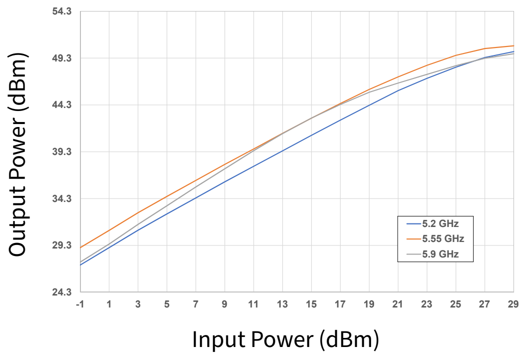

Figure 13. Output Power vs Input Power as a Function of Frequency

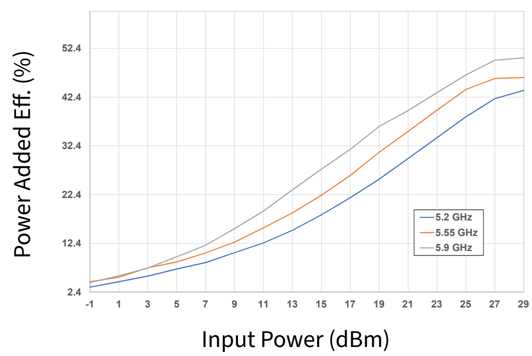

Figure 14. Power Added Eff. vs Input Power as a Function of Frequency

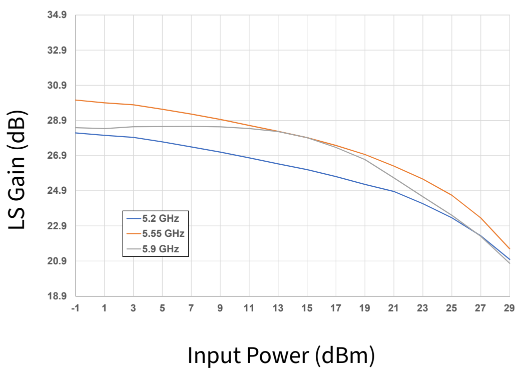

Figure 15. Large Signal Gain vs Input Power as a Function of Frequency

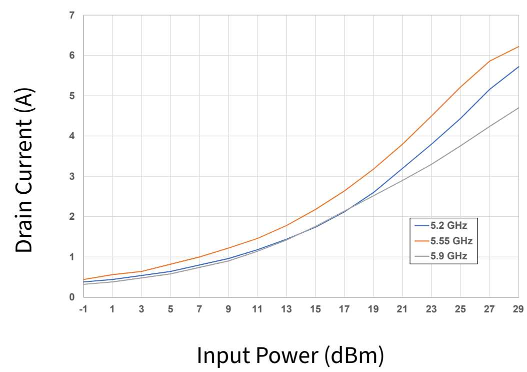

Figure 16. Drain Current vs Input Power as a Function of Frequency

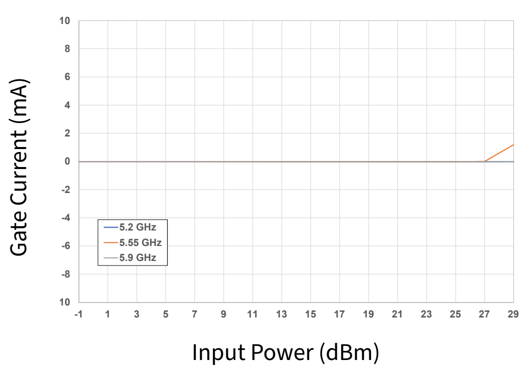

Figure 17. Gate Current vs Input Power as a Function of Frequency

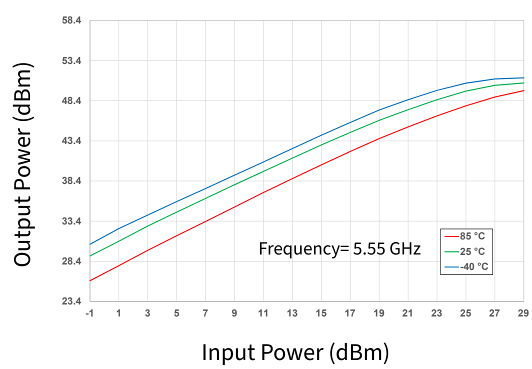

Figure 18. Output Power vs Input Power as a Function of Temperature

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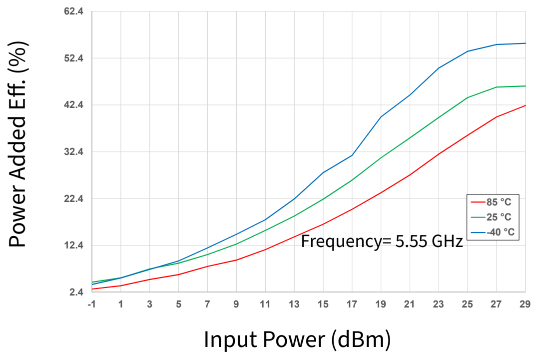

Figure 19. Power Added Eff. vs Input Power as a Function of Temperature

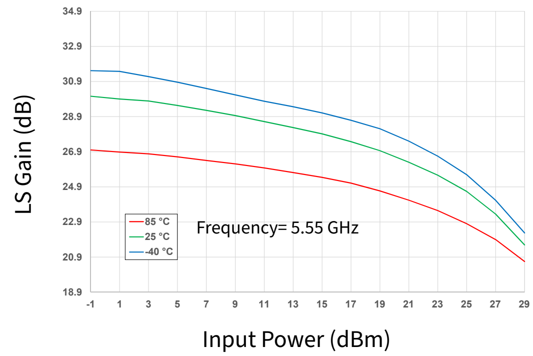

Figure 20. Large Signal Gain vs Input Power as a Function of Temperature

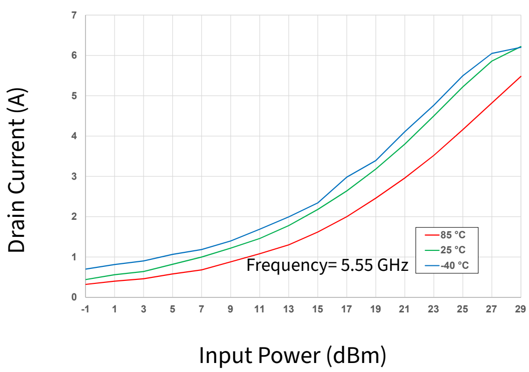

Figure 21. Drain Current vs Input Power as a Function of Temperature

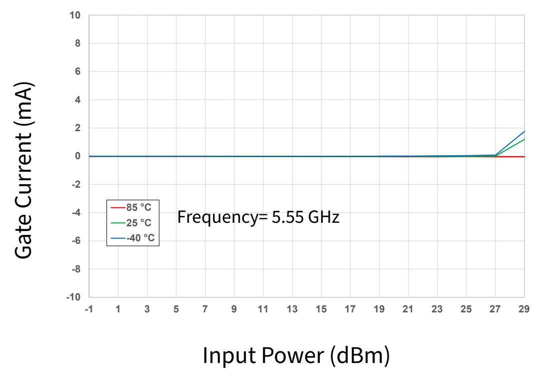

Figure 22. Gate Current vs Input Power as a Function of Temperature

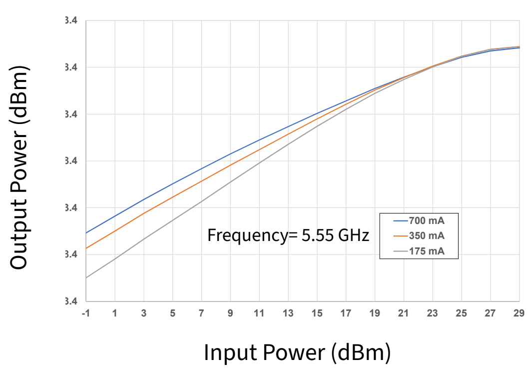

Figure 23. Output Power vs Input Power as a Function of I_{DQ}

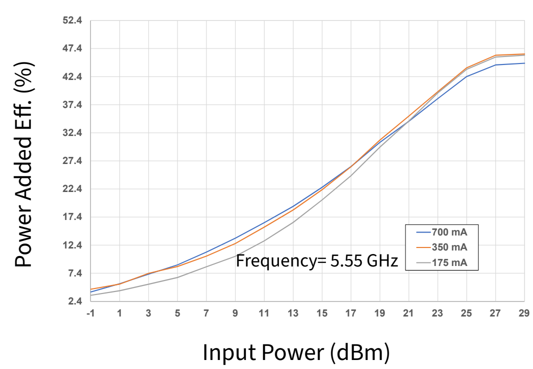

Figure 24. Power Added Eff. vs Input Power as a Function of I_{DQ}

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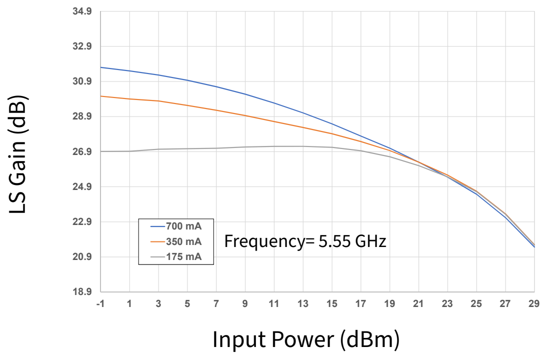

Figure 25. Large Signal Gain vs Input Power as a Function of I_{DQ}

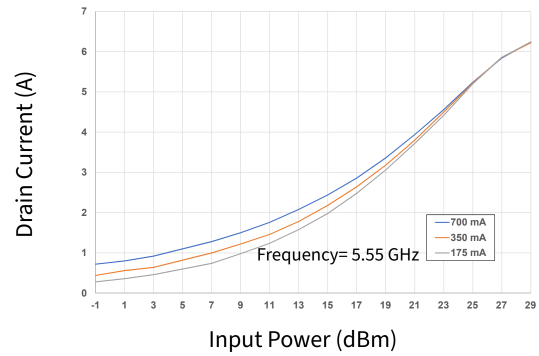

Figure 26. Drain Current vs Input Power as a Function of I_{DQ}

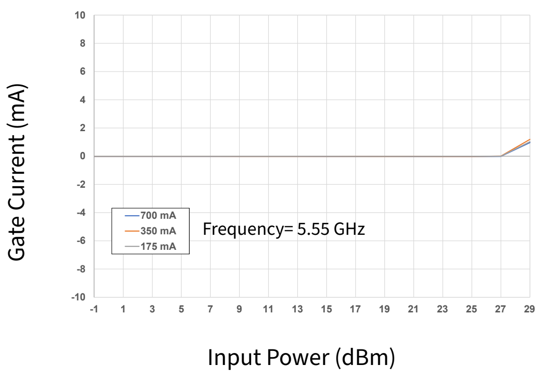

Figure 27. Gate Current vs Input Power as a Function of I_{DQ}

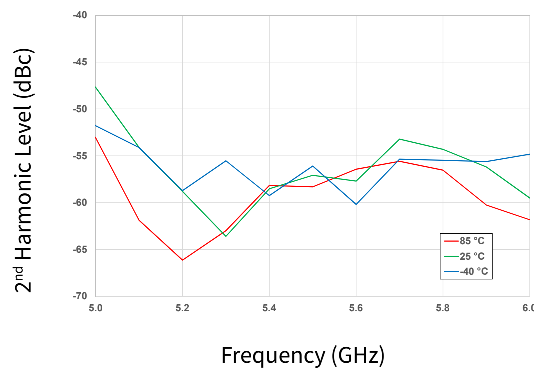

Figure 28. 2nd Harmonic vs Frequency as a Function of Temperature

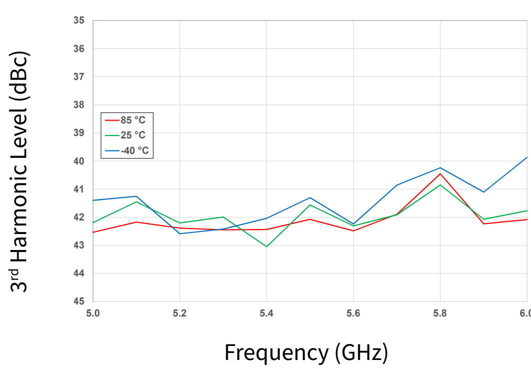

Figure 29. 3rd Harmonic vs Frequency as a Function of Temperature

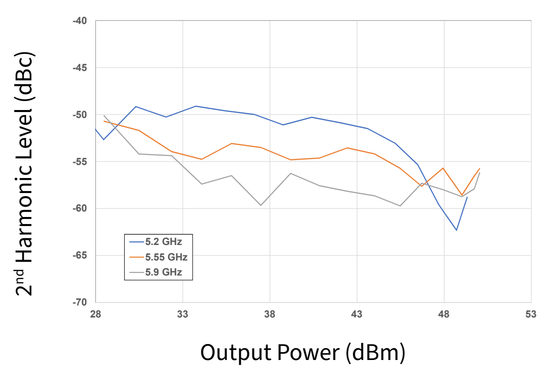

Figure 30. 2nd Harmonic vs Output Power as a Function of Frequency

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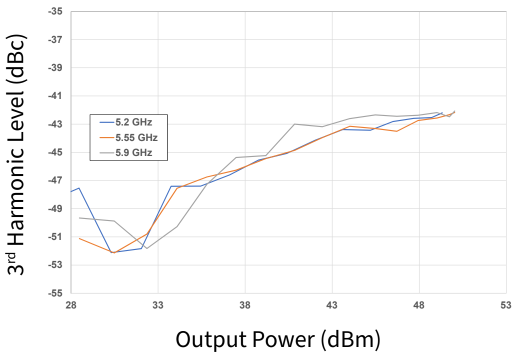

Figure 31. 3rd Harmonic vs Output Power as a Function of Frequency

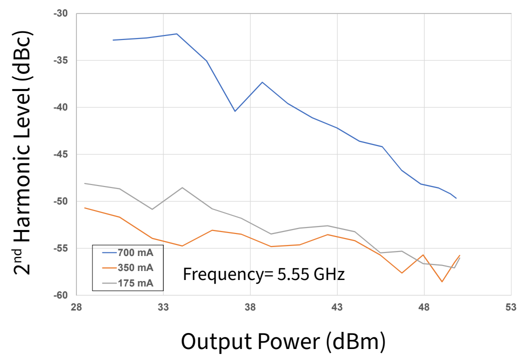

Figure 32. 2nd Harmonic vs Output Power as a Function of I_{DQ}

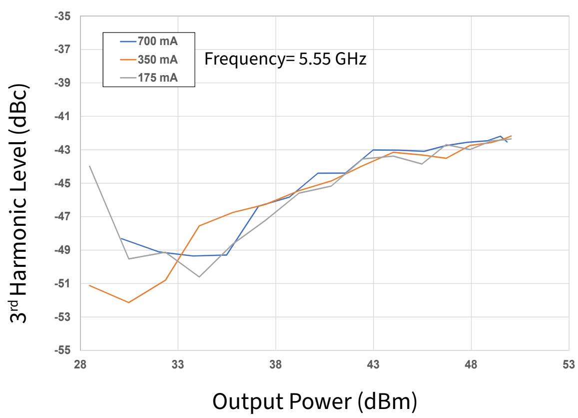

Figure 33. 3rd Harmonic vs Output Power as a Function of I_{DQ}

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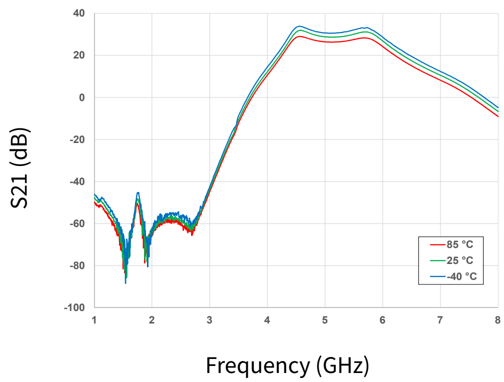

Figure 34. Gain vs Frequency as a Function of Temperature

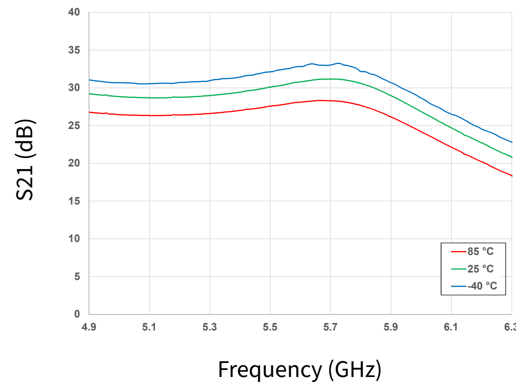

Figure 35. Gain vs Frequency as a Function of Temperature

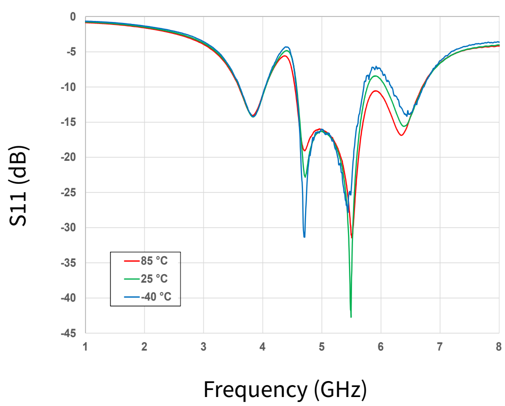

Figure 36. Input RL vs Frequency as a Function of Temperature

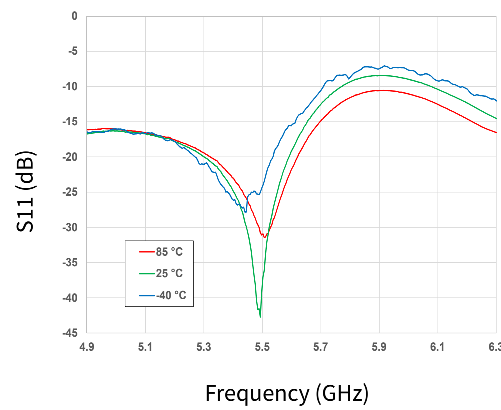

Figure 37. Input RL vs Frequency as a Function of Temperature

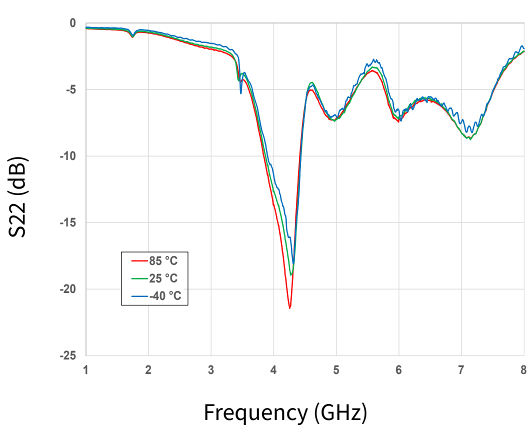

Figure 38. Output RL vs Frequency as a Function of Temperature

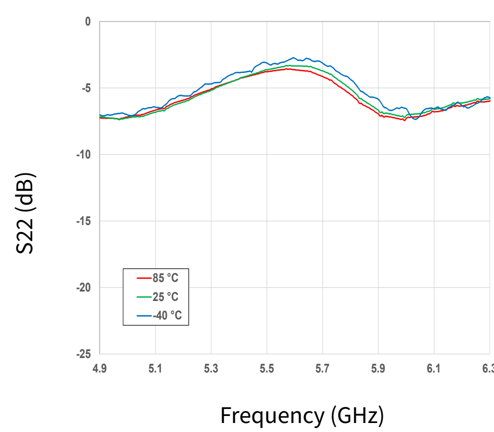

Figure 39. Output RL vs Frequency as a Function of Temperature

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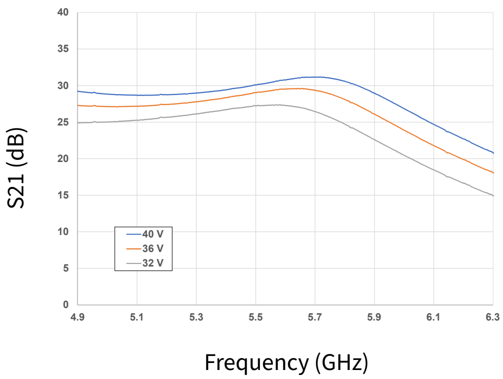

Figure 40. Gain vs Frequency as a Function of Voltage

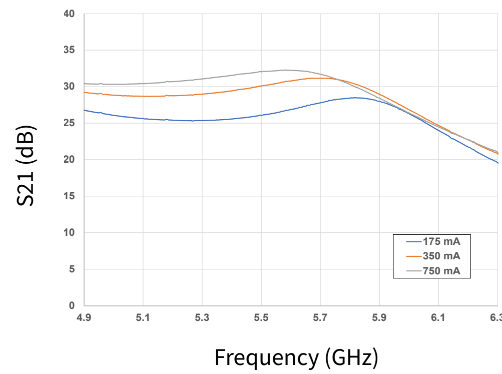

Figure 41. Gain vs Frequency as a Function of I_{DQ}

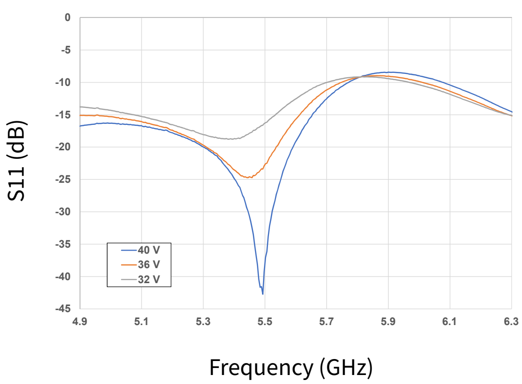

Figure 42. Input RL vs Frequency as a Function of Voltage

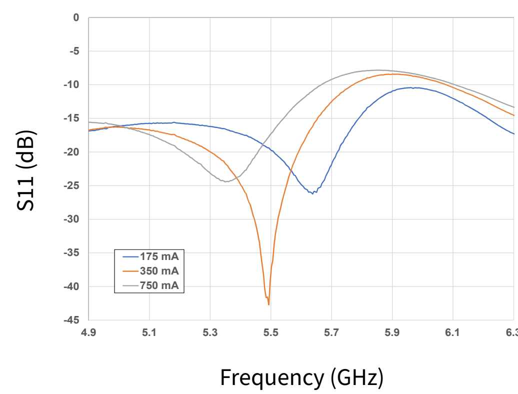

Figure 43. Input RL vs Frequency as a Function of I_{DQ}

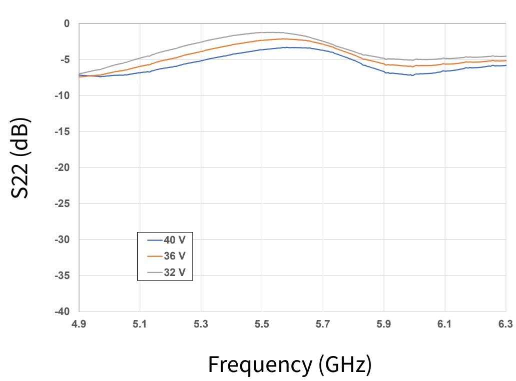

Figure 44. Output RL vs Frequency as a Function of Voltage

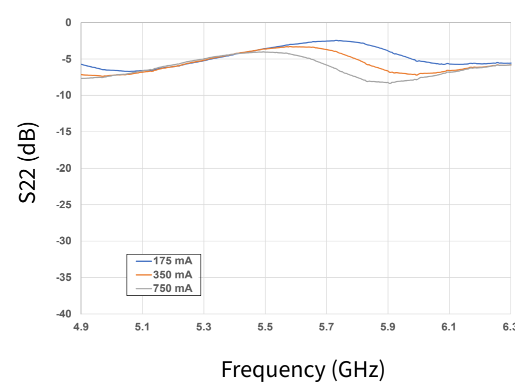

Figure 45. Output RL vs Frequency as a Function of I_{DQ}

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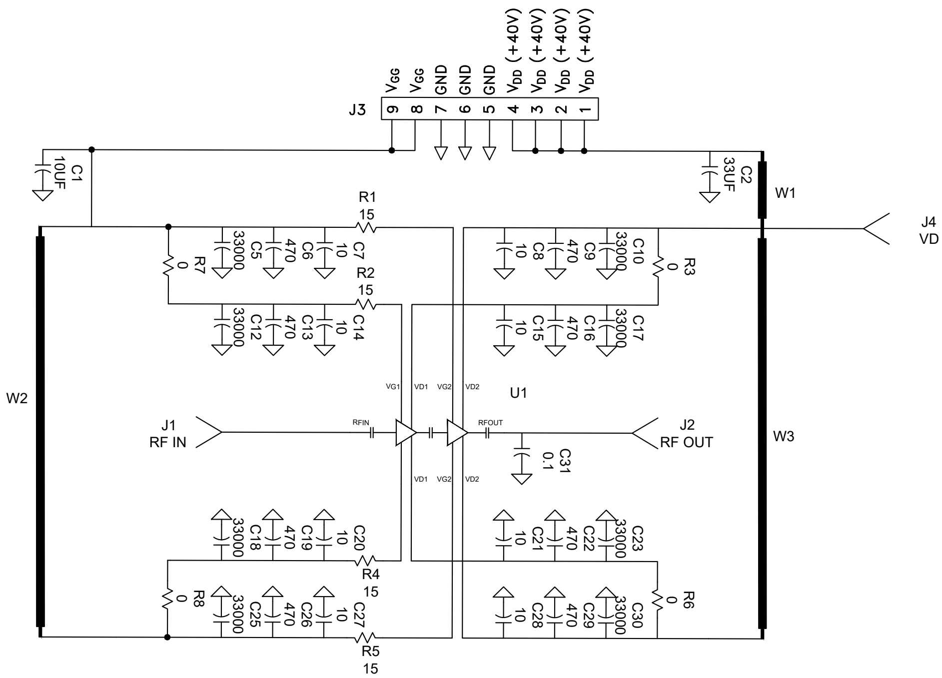
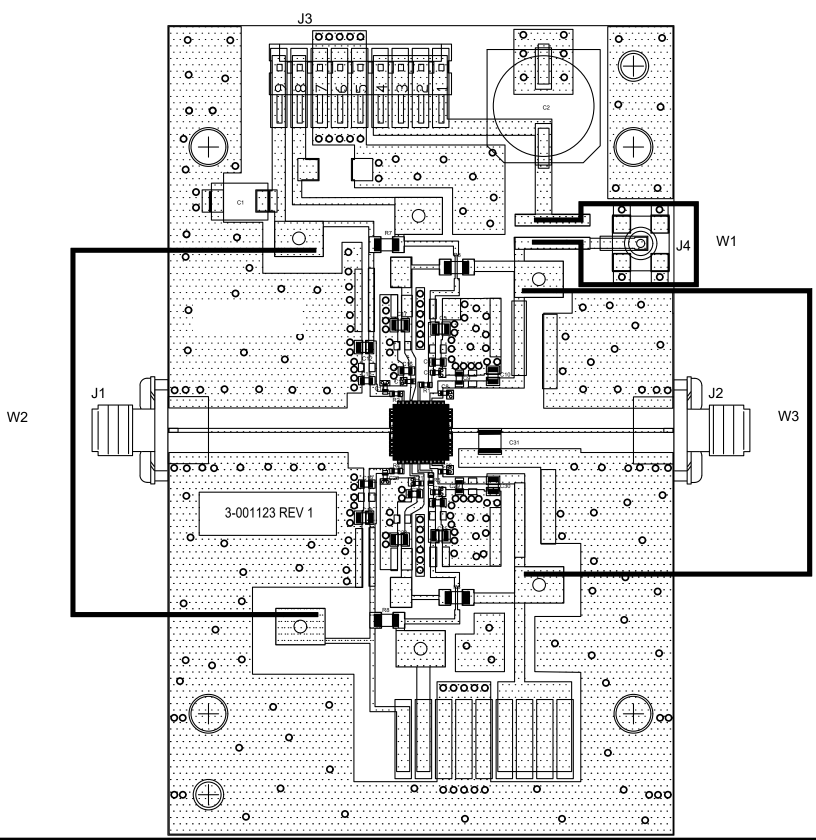
CMPA5259080S-AMP1 Demonstration Amplifier Schematic



CMPA5259080S-AMP1 Demonstration Amplifier Circuit Outline



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CMPA5259080S-AMP1 Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C7, C8, C14, C15, C20, C21, C27, C28	CAP, 10 pF, +/-5%, pF, 200 V, 0402	8
C6, C9, C13, C16, C29, C22, C26, C29	CAP, 470 pF, 5%, 100 V, 0603, X	8
C5, C10, C12, C17, C18, C23, C25, C30	CAP, 33000 pF, 0805, 100 V, X7R	8
C2	CAP, 33 UF, 20%, G CASE	1
C1	CAP, 10 UF, 16 V, TANTALUM	1
C31	CAP, 0.1 pF, ATC 100 B	1
R1, R2, R4, R5	RES 15 OHM, +/-1%, 1/16 W, 0402	4
R3, R6, R7, R8	RES 0.0 OHM 1/16 W 0402 SMD	2
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20 MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 9POS	1
W2, W3	WIRE, BLACK, 22 AWG ~ 2.5”	2
W1	WIRE, BLACK, 22 AWG ~ 3.0”	1
	PCB, TEST FIXTURE, RF-35 TC, 0.010 THK, 7x7 AIR CAVITY QFN, EVAL BOARD	1
	2-56 SOC HD SCREW 3/16 SS	4
	#2 SPLIT LOCKWASHER SS	4
U1	CMPA5259080S	1

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1 B (≥ 500 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (≥ 200 V)	JEDEC JESD22 C101-C

Moisture Sensitivity Level (MSL) Classification

Parameter	Symbol	Level	Test Methodology
Moisture Sensitivity Level	MSL	3 (168 hours)	IPC/JEDEC J-STD-20

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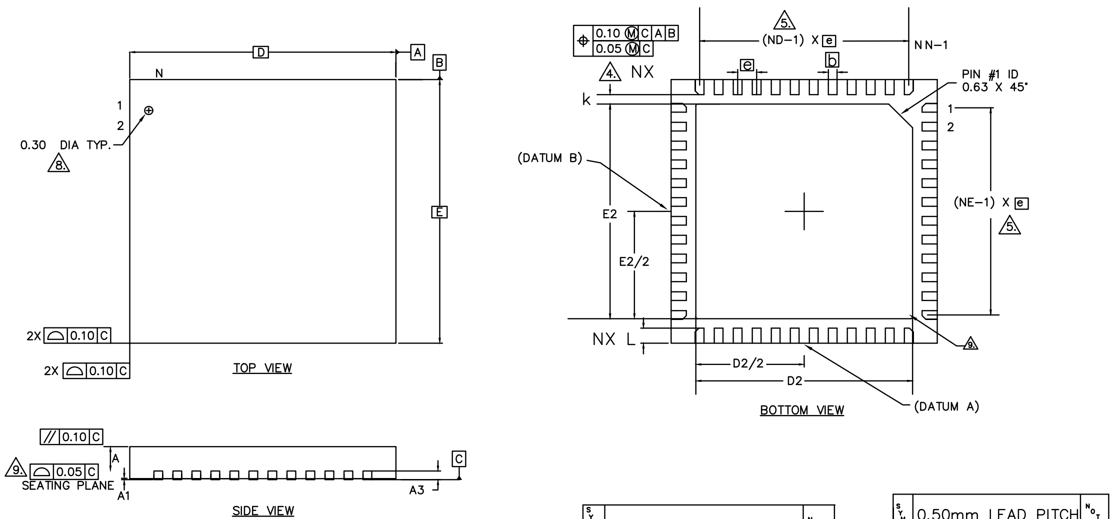
Product Dimensions CMPA5259080S (Package 7 x 7 QFN)

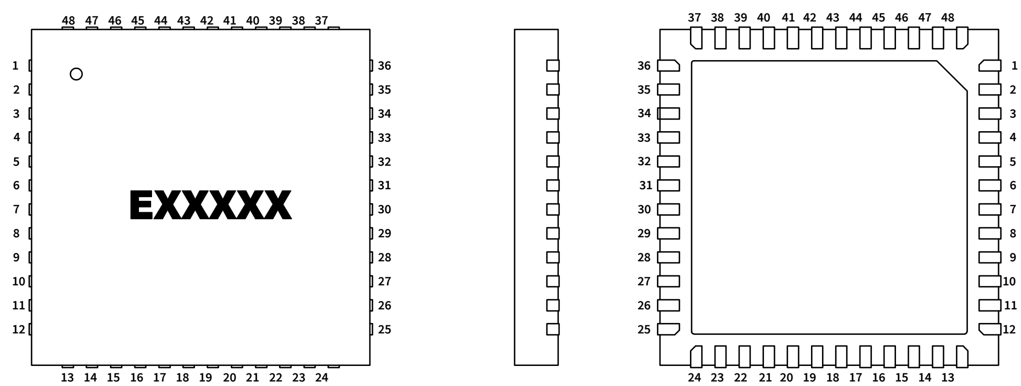


NOTES :

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M. − 1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS, θ IS IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP.
5. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
6. MAX. PACKAGE WARPAGE IS 0.05 mm.
7. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
8. PIN #1 ID ON TOP WILL BE LASER MARKED.
9. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
10. THIS DRAWING CONFORMS TO JEDEC REGISTERED OUTLINE MO−220
11. ALL PLATED SURFACES ARE TIN 0.010 mm +/− 0.005mm.

SYMBOL	MIN.	NOM.	MAX.	NOTE
A	0.80	0.86	0.91	
A1	0.00	0.03	0.06	
A3	0.20 REF.			
θ	0	—	12	2
K	0.20 MIN.			
D	7.0 BSC			
E	7.0 BSC			

SYMBOL	0.50mm LEAD PITCH			NOTE
	MIN.	NOM.	MAX.	
e	0.50 BSC.			
N	48			3
ND	12			5
NE	12			5
L	0.35	0.41	0.46	
b	0.19	0.25	0.33	4
D2	5.61	5.72	5.83	
E2	5.61	5.72	5.83	



Pin	Desc.	Pin	Desc.	Pin	Desc.	Pin	Desc.	Pin	Desc.
1	NC	11	NC	21	VD2A	31	RF_OUT	41	NC
2	NC	12	NC	22	VD2A	32	RF_GND	42	NC
3	NC	13	NC	23	NC	33	NC	43	VG2B
4	NC	14	VG1A	24	NC	34	NC	44	NC
5	RF_GND	15	NC	25	NC	35	NC	45	VD1B
6	RF_IN	16	VD1A	26	NC	36	NC	46	NC
7	RF_GND	17	NC	27	NC	37	NC	47	VG1B
8	NC	18	VG2A	28	NC	38	NC	48	NC
9	NC	19	NC	29	NC	39	VD2B		
10	NC	20	NC	30	RF_GND	40	VD2B		

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Part Number System

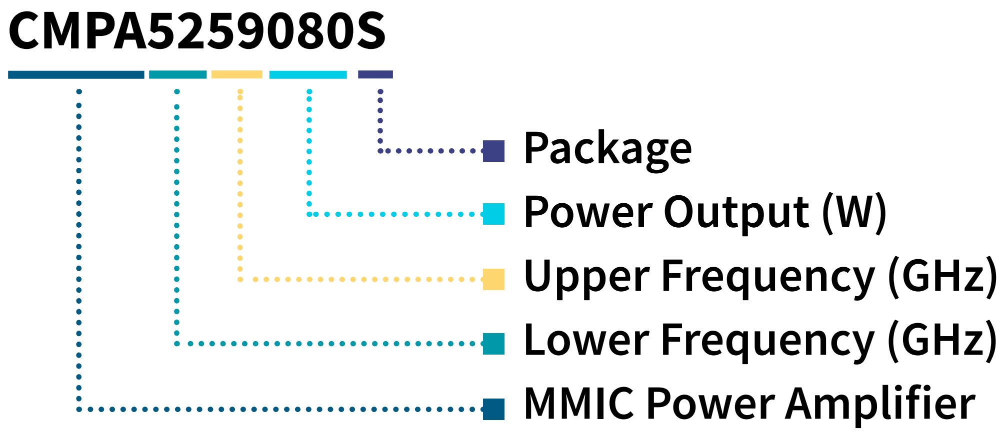

Table 1.

Parameter	Value	Units
Lower Frequency	5.2	GHz
Upper Frequency	5.9	GHz
Power Output	80	W
Package	Surface Mount	–

Note:
Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1 A = 10.0 GHz 2 H = 27.0 GHz

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Rev. 0.2, SEPTEMBER 2023

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA5259080S	GaN HEMT	Each	
CMPA5259080S-AMP1	Test Board with GaN MMIC Installed	Each	

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